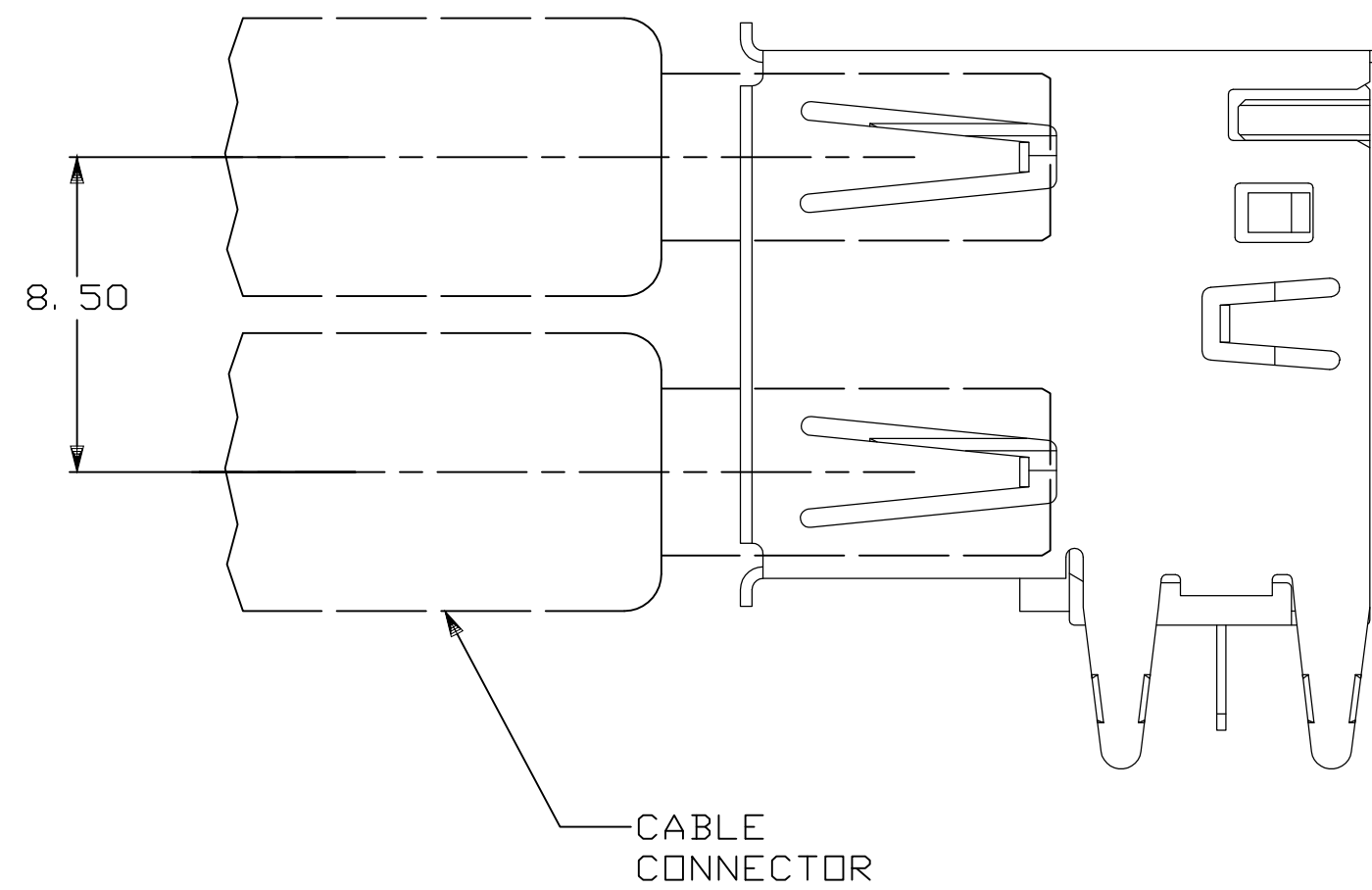
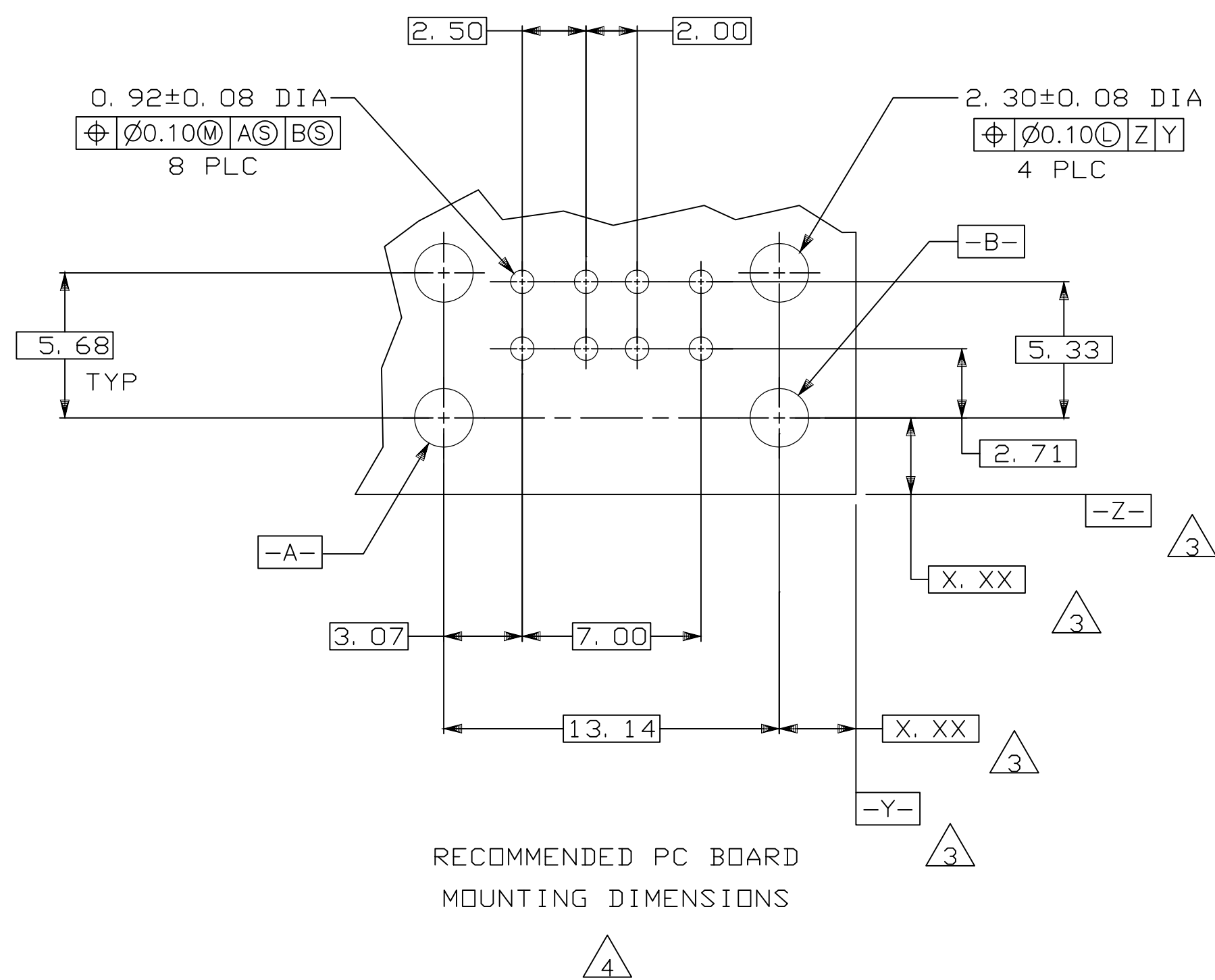
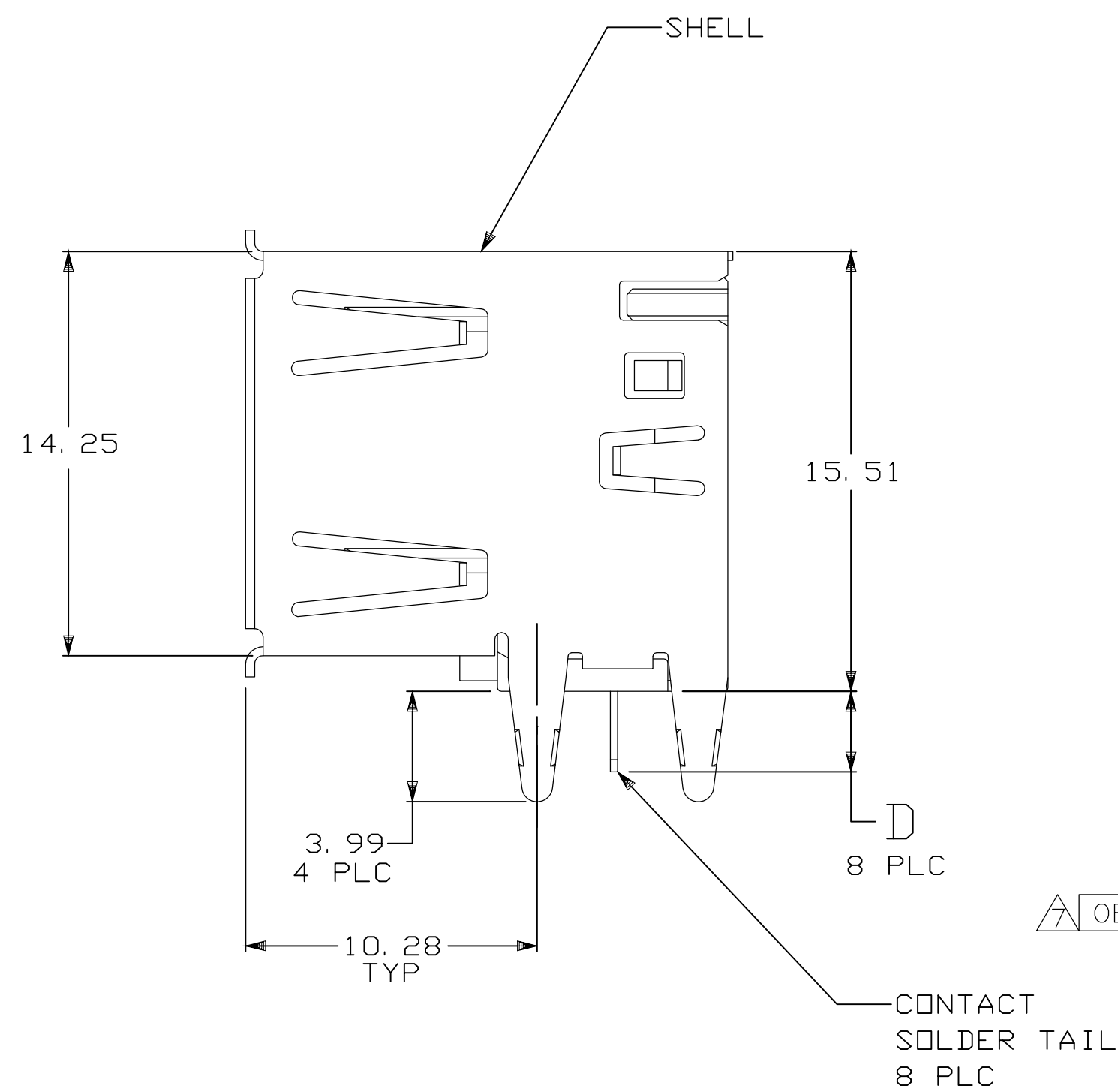




- 1 MATERIAL:
SHELL & CONTACTS- COPPER ALLOY.
HOUSING- UL 94V-0 RATED, THERMOPLASTIC, SEE TABLE.
- 2 PLATING:
CONTACTS- 0.076um MINIMUM GOLD OVER 0.76um MINIMUM
PALLADIUM-NICKEL ON MATING AREA. OR CONTACT ALTRENAME
PLATING 0.76um MINIMUM GOLD ON MATING AREA.
3. 80um MINIMUM MATTE TIN ON SOLDER TAILS.
BOTH OVER 1.27um MINIMUM NICKEL.
SHELL: 2~5um MINIMUM BRIGHT TIN
- 3 DATUM AND BASIC DIMENSIONS ESTABLISHED BY CUSTOMER.
- 4 RECOMMENDED PC BOARD THICKNESS OF 1.57.
- 5 PLATING:
CONTACTS- 0.127um MINIMUM GOLD ON MATING AREA,
3. 80um MINIMUM MATTE TIN ON SOLDER TAILS.
ALL OVER .76um MINIMUM NICKEL ON ENTIRE CONTACT.
SHELL: 2~5um MINIMUM BRIGHT TIN
- 6 PACKAGED IN TRAYS
- 7 OBSOLETE PARTS: OBSOLETE CIS STREAMLINING PER D. RENAUD/D. SINISI

4805 (3/11)

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